Features

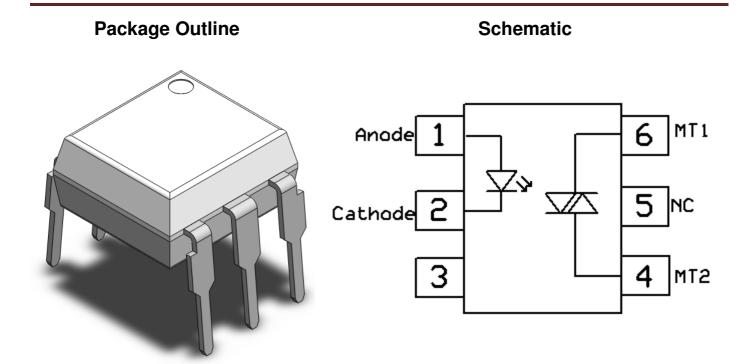
- High isolation 5000 VRMS
- Peak Breakdown Voltage
 - 250V CT3010,3011,3012
 - 400V CT3020,3021,3022,3023
- Temperature range 55 ℃ to 100 ℃
- RoHS compliance
- REACH compliance
- Halogen compliance(Optional)
- Regulatory Approvals
 - UL UL1577 (E364000)
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - IEC60065, IEC60950

Description

The CT3010, CT3011, CT3012, CT3020, CT3021, CT3022 and CT3023 consists of a Random Phase Photo Triac optically coupled to a gallium arsenide Infrared-emitting diode in a 6-lead DIP package with different lead forming options.

Applications

- Motor Controls
- Lamp ballasts
- Static AC Power Switch
- Solenoid/ Valve Control



Note: Different lead forming options available. See package

dimension.



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes	
Viso	Isolation voltage		5000	V _{RMS}	
Topr	Operating temperature		-55 ~ +100	°C	
Tstg	Storage temperature		-55 ~ +150	°C	
Tsol	Soldering temperature		260	°C	
Emitter		·		·	
lF	Forward current	60	mA		
IF(TRANS)	Peak transient current (≤1µs P.W,300p	1	Α		
VR	Reverse voltage		6	V	
PD	Power dissipation	100	mW		
Detector					
PD	Power dissipation		300	mW	
		CT3010,3011,3012	250	V	
V _{DRM}	Off-State Output Terminal Voltage	CT3020,3021,3022,3023	400	V	
Ітям	Peak Repetitive Surge Current	1	Α		



Electrical Characteristics T_A = 25 °C (unless otherwise specified)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	I⊧=10mA	-	-	1.5	V	
IR	Reverse Current	V _R = 6V	-	-	5	μA	
CIN	Input Capacitance	f= 1MHz	-	45	-	pF	

Detector Characteristics

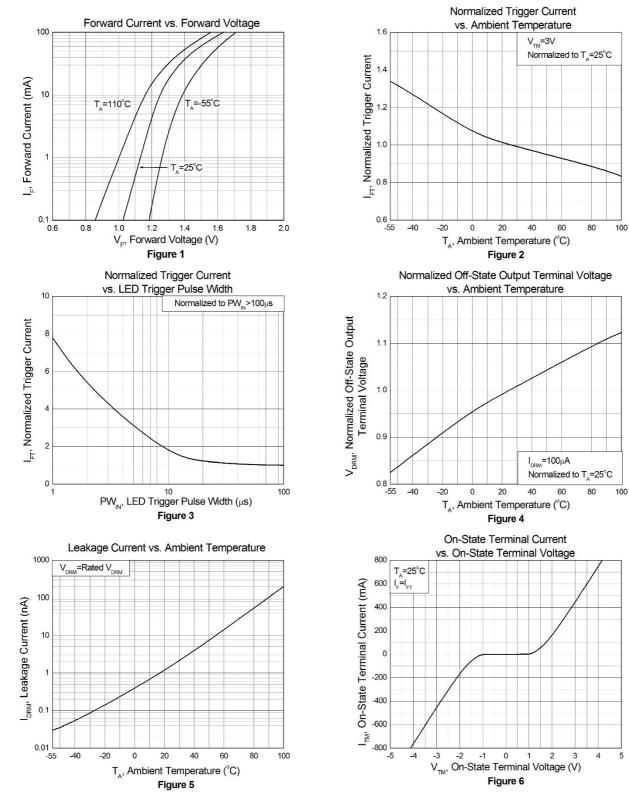
Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
Idrm	Peak Blocking Current	IF= 0mA, VDRM= Rated VDRM	-	-	100	nA	
VTM	Peak On-State Voltage	IF= Rated IFT, ITM= 100mA	-	-	2.5	V	
dv/dt	Critical Rate of Rise off-State	VPEAK= Rated VDRM	-	100	-	V/µs	
	Voltage						

Transfer Characteristics

Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	laavat	CT3020		-	-	30		
	Input	CT3010, CT3021	Terminal Voltage = 3V	-	-	15	m 4	
IFT	Trigger Current	CT3011, CT3022	I _{TM} =100mA	-	-	10	mA	
	Current	CT3012, CT3023		-	-	5		
Ін	Holding Current			-	250	-	μA	
Rio	Isolation Resistance		V _{IO} = 500V _{DC}	1x10 ¹¹	-	-	Ω	
CIO	Isolation Capacitance		f= 1MHz	-	0.25	-	pF	

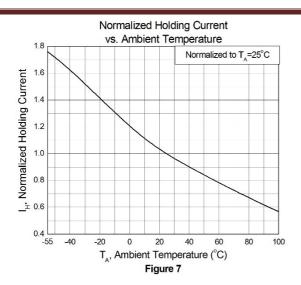


Typical Characteristic Curve



5

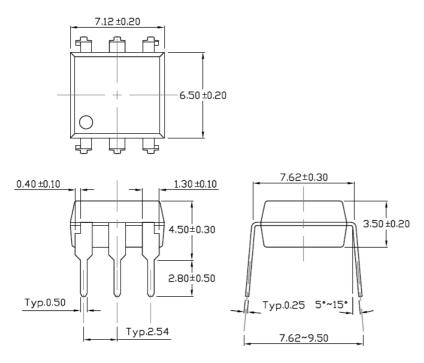




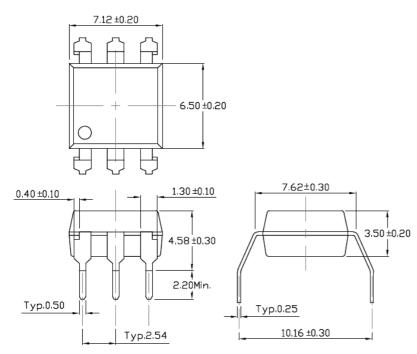


Package Dimension Dimensions in mm unless otherwise stated

Standard DIP – Through Hole

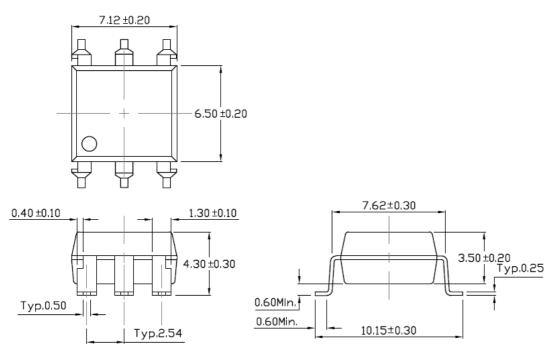


Wide Lead Forming – Through Hole (M Type)

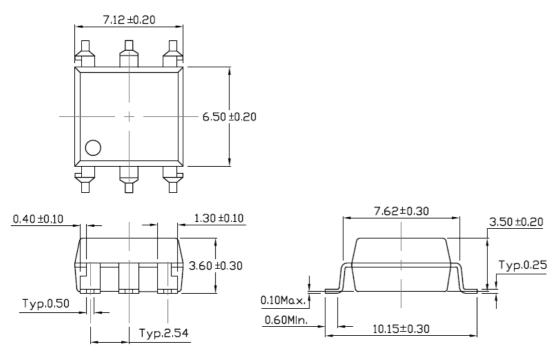




Surface Mount Forming (S Type)

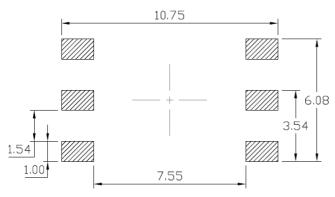


Surface Mount Forming (Low Profile) (SL Type)

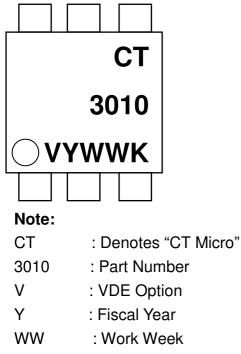




Recommended Solder Mask Dimensions in mm unless otherwise stated



Marking Information



K : Manufacturing Code



CT3010, CT3011, CT3012 CT3020, CT3021, CT3022, CT3023

250V/400V Random Phase 6-Pin Phototriac Optocoupler

Ordering Information

CT301X(V)(Y)(Z)-G, CT302X(V)(Y)(Z)-G

X = Part No. (CT301X:0,1,2), (CT302X : 0,1,2,3)

V = VDE Option (V or none)

Y = Lead form option (S, SL, M or none)

Z = Tape and reel option (T1, T2 or none)

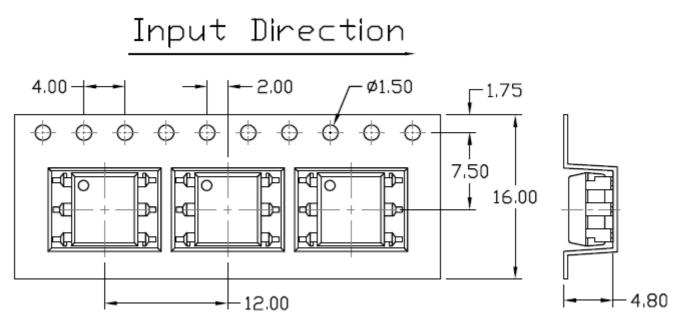
G= Material option (G: Green, None: Non-green)

Option	Description	Quantity
None	Standard 6 Pin Dip	50Units/Tube
М	Gullwing (400mil) Lead Forming	50Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming – With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1000 Units/Reel

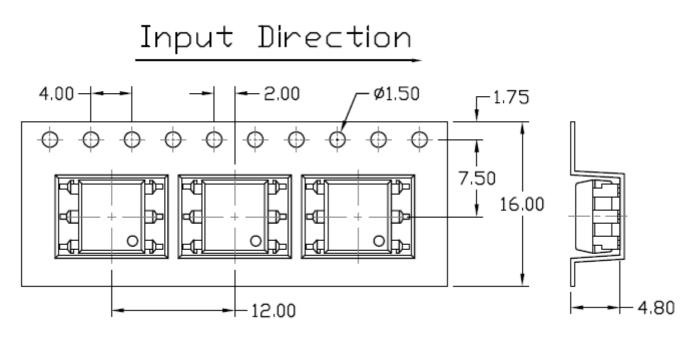


Carrier Tape Specifications Dimensions in mm unless otherwise stated

Option S(T1) & SL(T1)

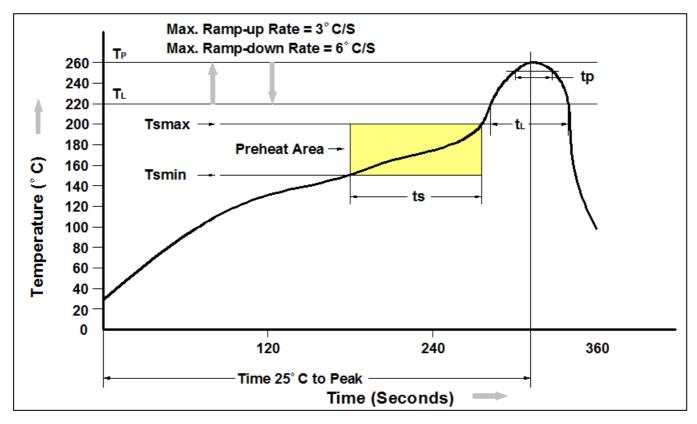


Option S(T2) & SL(T2)





Reflow Profile



Profile Feature	Pb-Free Assembly Profile		
Temperature Min. (Tsmin)	150 <i>°</i> C		
Temperature Max. (Tsmax)	200 <i>°</i> C		
Time (ts) from (Tsmin to Tsmax)	60-120 seconds		
Ramp-up Rate (t_L to t_P)	3℃/second max.		
Liquidous Temperature (TL)	217℃		
Time (t _L) Maintained Above (T _L)	60 – 150 seconds		
Peak Body Package Temperature	260 ℃ +0 ℃ / -5 ℃		
Time (t _P) within 5 ℃ of 260 ℃	30 seconds		
Ramp-down Rate (T _P to T _L)	6°C/second max		
Time 25℃ to Peak Temperature	8 minutes max.		



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